



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Bily WANG

Serial No. 10/697610

Filed: Oct. 31, 2003

For: IC PACKAGE WITH STACKED SHEET METAL SUBSTRATE

OFFICIAL RECEIPT

Initial Application Dept.

Commission of Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

The above-identified patent application was filed and the application fee was paid on Oct. 31, 2003, as shown in the following copy of the return postcard. However, to date, I have not received an official receipt. Please check and issue us an official receipt. Thank you.

Respectfully submitted,

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Serial No. \_\_\_\_\_; File No. 10/697610  
In the Matter of the Application of Bily WANG et al.  
For IC Package with Stacked Sheet Metal Substrate  
The following has been received in the U.S. Patent  
Office on this date stamped hereon:

- ☒ 6 pps. Specification & 8 Claims
- ☒ Combined Declaration, Petition & Power of Attorney
- ☐ Letter Requesting Approval of Drawing Changes
- ☒ Check for \$425.00
- ☒ Drawings 01 Sheets
- ☒ Assignment
- ☐ Letter to Official Draftsman
- ☐ Amendment
- ☐ Restriction Response
- ☐ Petition
- ☐
- ☐

22264 U.S. PTO  
10/697610



Certificate of Mailing

I hereby certify that this Fee(s) Transmittal is being deposited with the United States Postal Service with sufficient postage for first class mail in an envelope addressed to the Box Issue Fee address above on the date indicated below.

Hung Chang Lin

(Depositor's name)

Hung Chang Lin

(Signature)

4/3/04

(Date)